

General Description

The MY5N65D is silicon N-channel Enhanced VDMOSFETS, obtained by the self-aligned planar Technology which reduce the conduction loss, improve switching performance and enhance the avalanche energy.

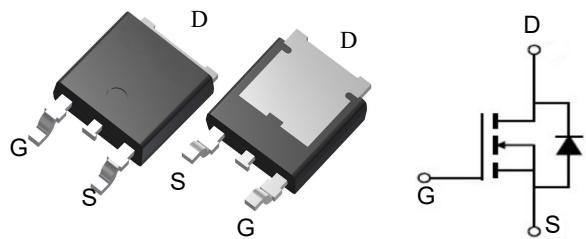


Features

V _{DSS}	650	V
I _D	5	A
P _D (T _C = 25 °C)	36	W
R _{DS(ON)} (at V _{GS} = 10V)	2	Ω

Application

- High efficiency switch mode power supplies
- Power factor correction
- Electronic lamp ballast



Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
MY5N65D	TO-252	MY5N65D	2500

Absolute Maximum Ratings (T_c=25 °C unless otherwise noted)

Symbol	Parameters	Ratings	Unit
V _{DSS}	Drain-Source Voltage	650	V
V _{GS}	Gate-Source Voltage-Continuous	±30	V
I _D	Drain Current-Continuous (Note 2)	5	A
I _{DM}	Drain Current-Single Plused (Note 1)	18	A
P _D	Power Dissipation (Note 2)	36	W
T _j	Max.Operating junction temperature	150	°C/W

Electrical Characteristics (T_c=25 °C, unless otherwise noted)

Symbol	Parameters	Min	Typ	Max	Units	Conditions
Static Characteristics						
B _{VDSS}	Drain-Source Breakdown VoltageCurrent (Note 1)	650	--	--	mA	I _D =250μA V _{GS} =0V , T _J =25°C
V _{GS(th)}	Gate Threshold Voltage	2.0	--	4.0	V	V _{DS} =V _{GS} , I _D =250μA
R _{DS(on)}	Drain-Source On-Resistance	--	2.0	2.5	Ω	V _{GS} =10V , I _D =2.5A
I _{GSS}	Gate-Body Leakage Current	--	--	±100	nA	V _{GS} =±30V , V _{DS} =0
I _{DS}	Zero Gate Voltage Drain Current	--	--	1	μA	V _{DS} =650V , V _{GS} =0
g _{fs}	Forward Transconductance	1.2	--	--	S	V _{DS} =15V, I _D =2.5A
Switching Characteristics						
T _{d (on)}	Turn-On Delay Time	--	20	40	ns	V _{DS} =325V , I _D =5A, R _G =25Ω (Note 2)
T _r	Rise Time	--	45	100	ns	
T _{d (off)}	Turn-Off Delay Time	--	35	75	ns	
T _f	Fall Time	--	35	85	ns	
Q _g	Total Gate Charge	--	15	20	nC	V _{DS} =520, V _{GS} =10V , I _D =5A (Note 2)
Q _{gs}	Gate-Source Charge	--	3.5	--	nC	
Q _{gd}	Gate-Drain Charge	--	7.5	--	nC	
Dynamic Characteristics						
C _{iss}	Input Capacitance	--	515	670	pF	V _{DS} =25V , V _{GS} =0, f=1MHz
C _{oss}	Output Capacitance	--	65	80	pF	
C _{rss}	Reverse Transfer Capacitance	--	7.5	10.5	pF	
I _s	Continuous Drain-Source Diode ForwardCurrent (Note 2)	--	--	5	A	
V _{SD}	Diode Forward On-Voltage	--	--	1.4	V	I _s =5A , V _{GS} =0
R _{th(j-c)}	Thermal Resistance, Junction to Case	--	--	3.47	°C/W	

Note 1: Repetitive Rating : Pulse width limited by maximum junction temperature

Note 2: Pulse test: PW <= 300us , duty cycle <= 2%.

Ratings and Characteristic curves

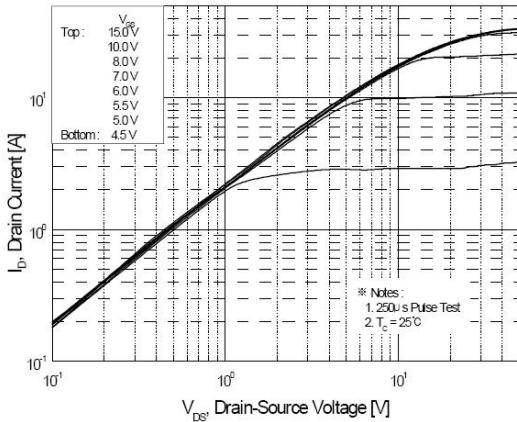


Figure 1. On-Region Characteristics

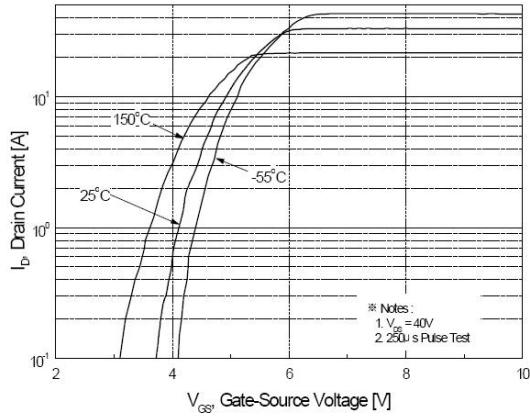


Figure 2. Transfer Characteristics

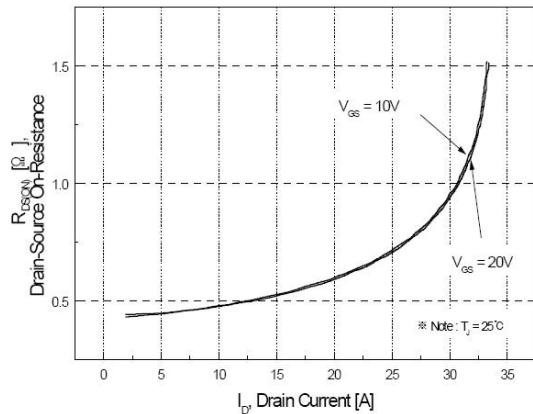
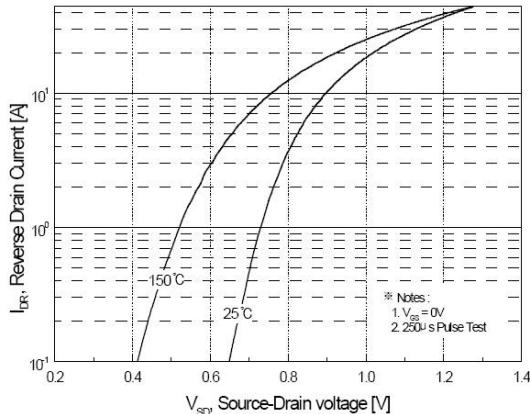
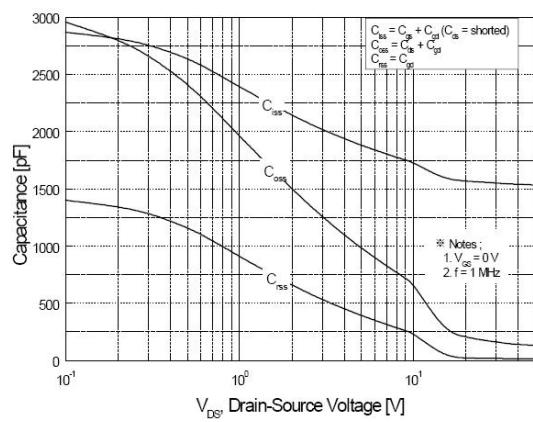
Figure 3. On-Resistance Variation vs
Drain Current and Gate VoltageFigure 4. Body Diode Forward Voltage
Variation with Source Current
and Temperature

Figure 5. Capacitance Characteristics

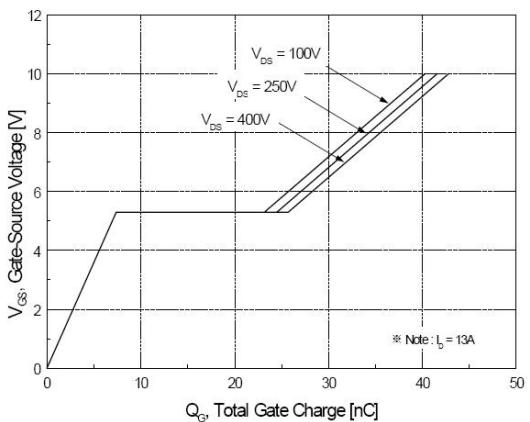
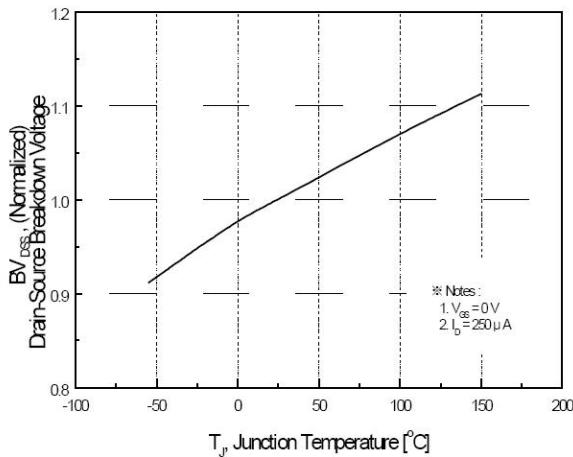
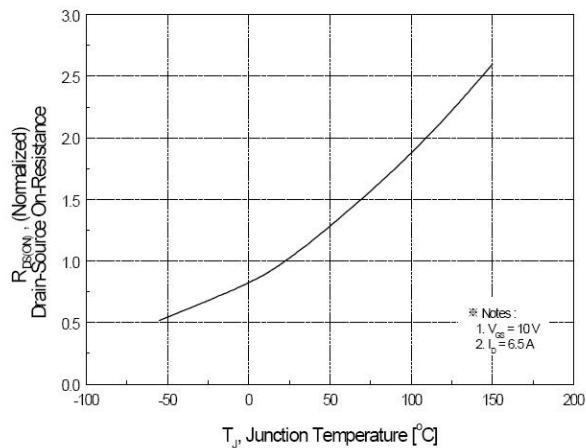


Figure 6. Gate Charge Characteristics



**Figure 7. Breakdown Voltage Variation
vs Temperature**



**Figure 8. On-Resistance Variation
vs Temperature**

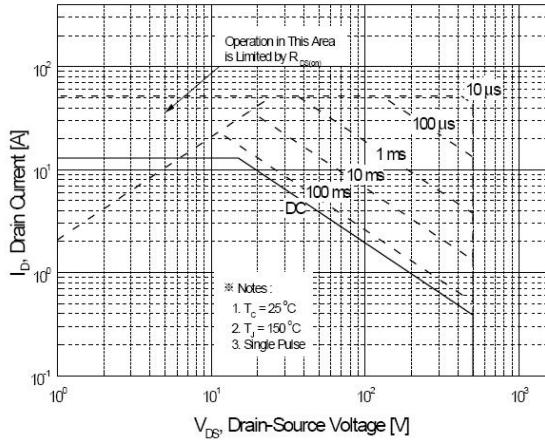
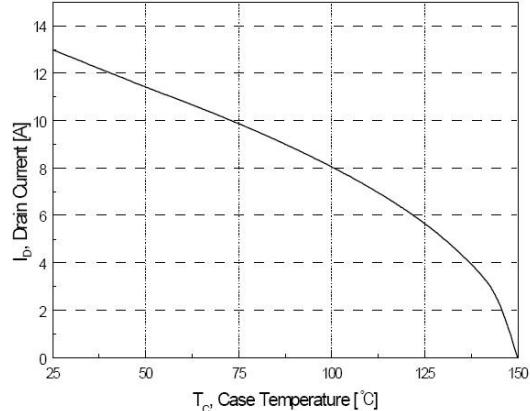


Figure 9. Maximum Safe Operating Area



**Figure 10. Maximum Drain Current
vs Case Temperature**

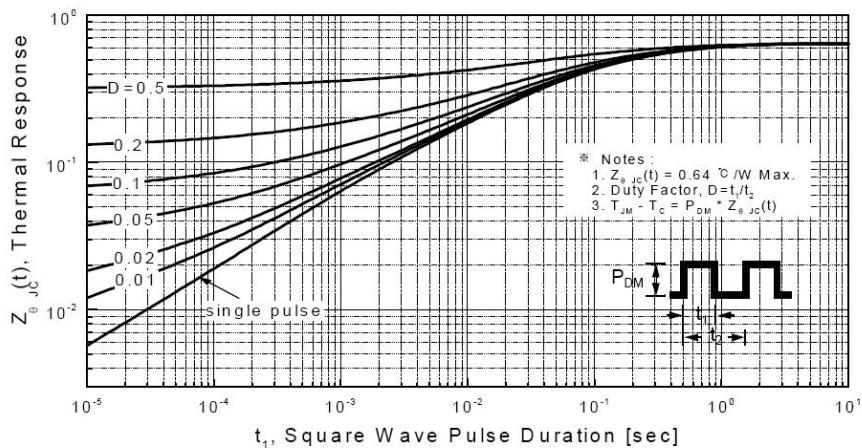


Figure 11. Transient Thermal Response Curve

Fig 12. Gate Charge Test Circuit & Waveform

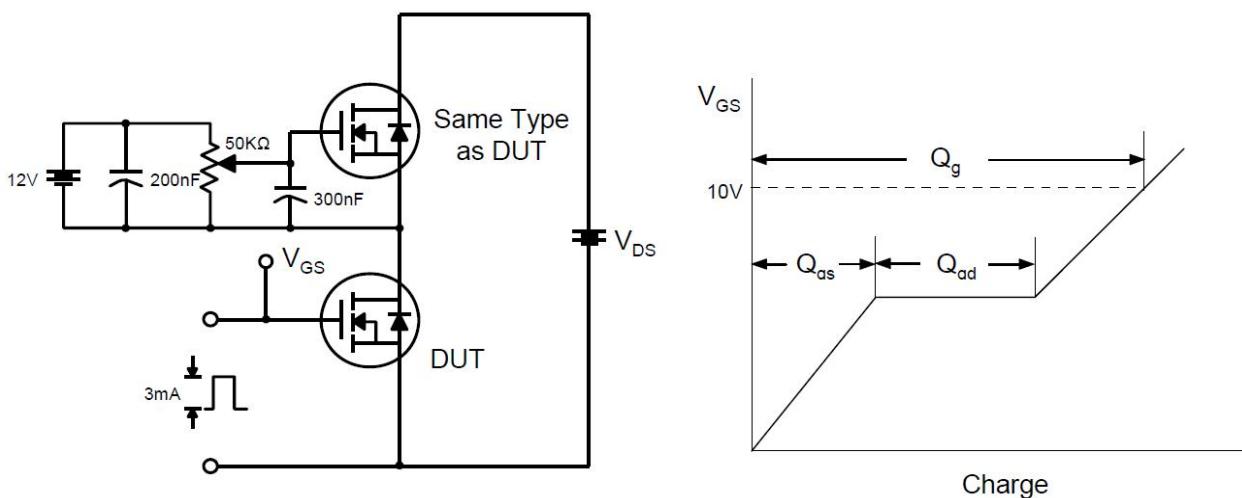


Fig 13. Resistive Switching Test Circuit & Waveforms

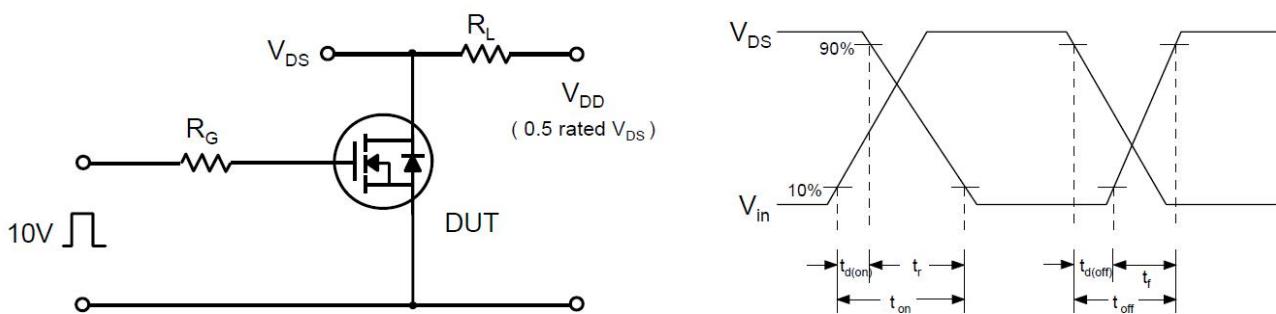


Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms

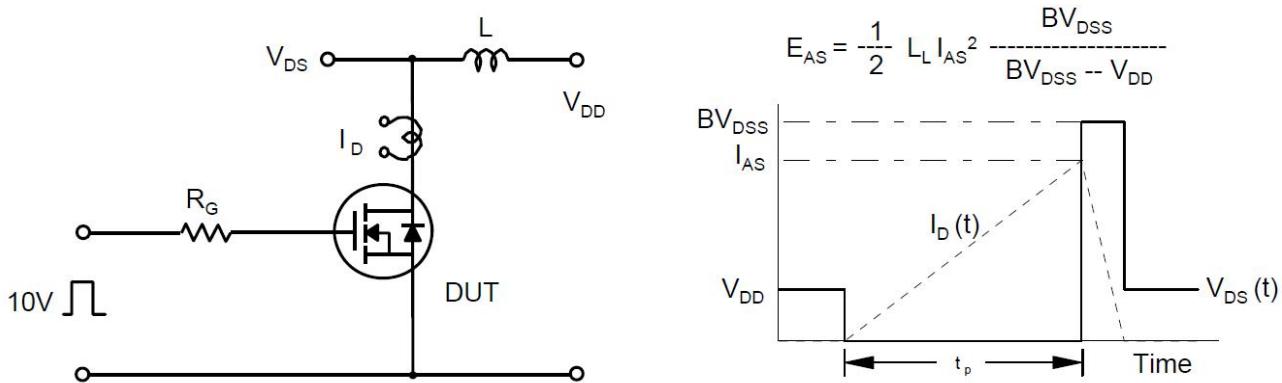
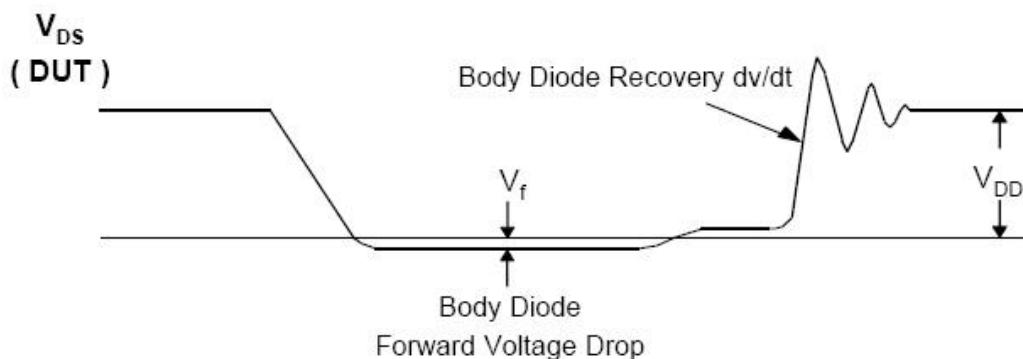
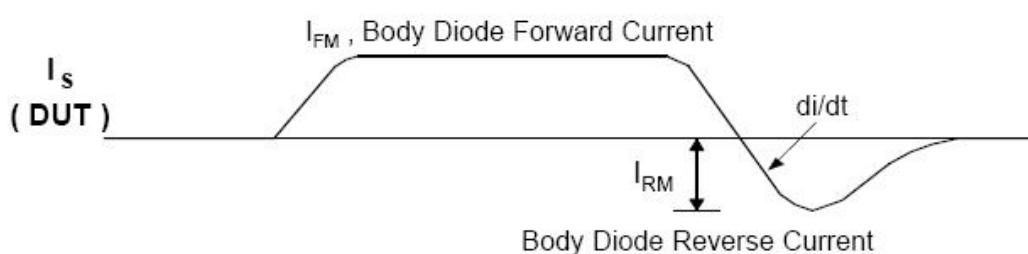
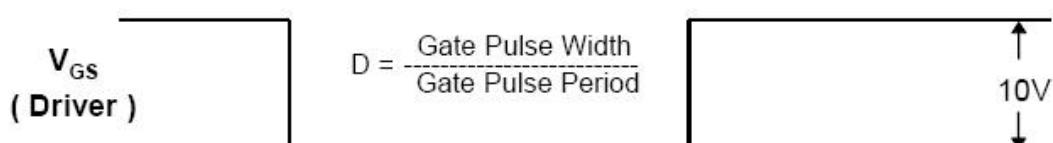
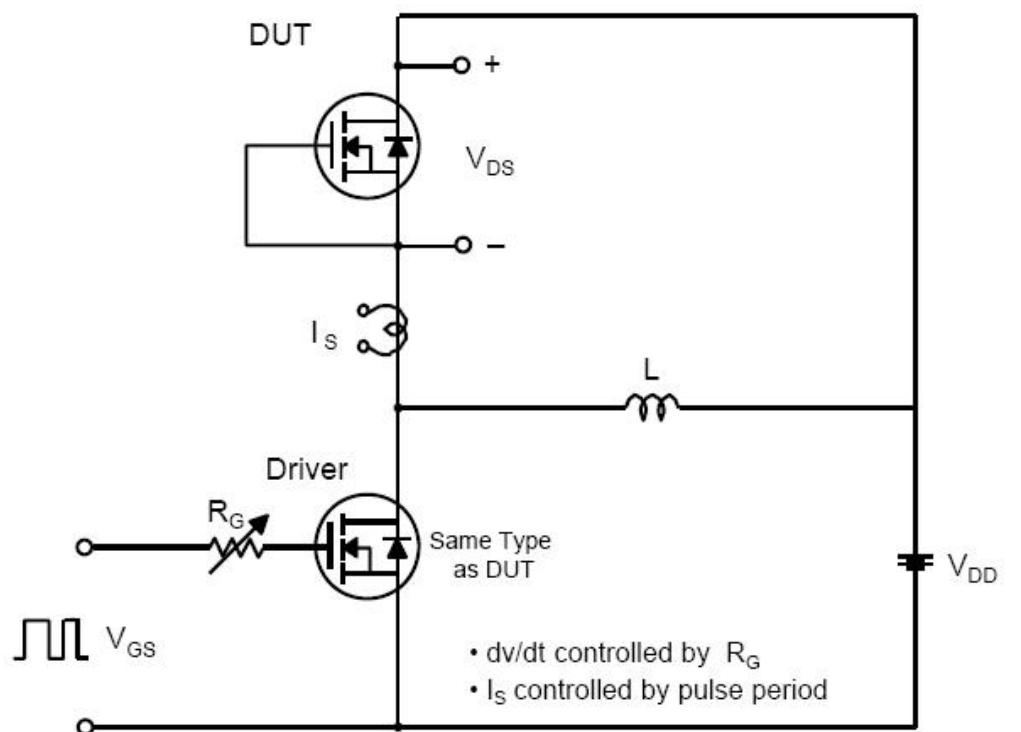
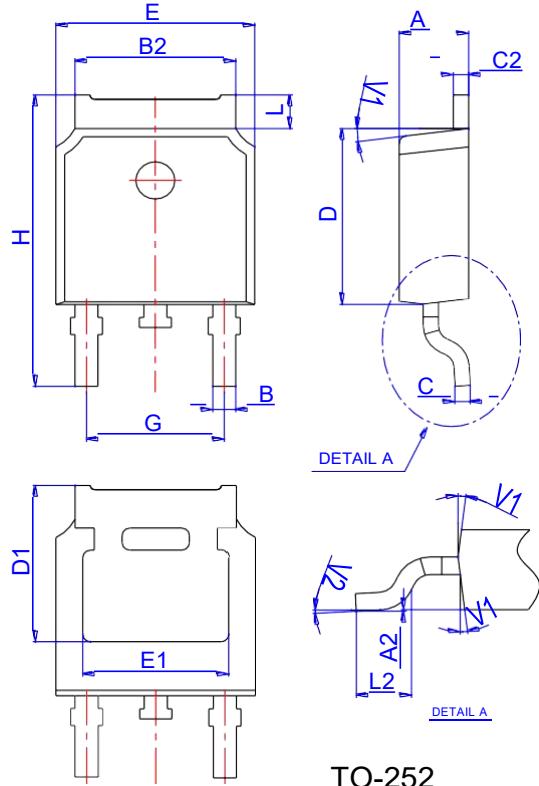


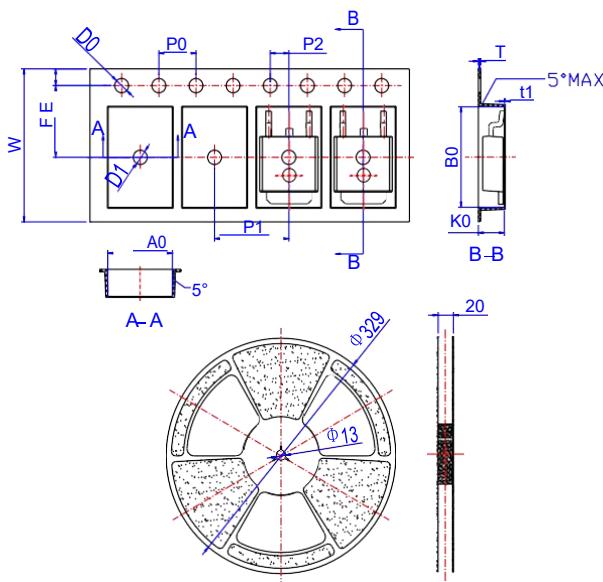
Fig 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms



Package Mechanical Data-TO-252-JQ Single


TO-252

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	2.10			2.50	0.083	
A2	0			0.10	0	
B	0.66			0.86	0.026	
B2	5.18			5.48	0.202	
C	0.40			0.60	0.016	
C2	0.44			0.58	0.017	
D	5.90			6.30	0.232	
D1	5.30REF			0.209REF		
E	6.40			6.80	0.252	
E1	4.63				0.182	
G	4.47			4.67	0.176	
H	9.50			10.70	0.374	
L	1.09			1.21	0.043	
L2	1.35			1.65	0.053	
V1		7°				7°
V2	0°			6°	0°	
						6°

Reel Specification-TO-252


Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
W	15.90	16.00	16.10	0.626	0.630	0.634
E	1.65	1.75	1.85	0.065	0.069	0.073
F	7.40	7.50	7.60	0.291	0.295	0.299
D0	1.40	1.50	1.60	0.055	0.059	0.063
D1	1.40	1.50	1.60	0.055	0.059	0.063
P0	3.90	4.00	4.10	0.154	0.157	0.161
P1	7.90	8.00	8.10	0.311	0.315	0.319
P2	1.90	2.00	2.10	0.075	0.079	0.083
A0	6.85	6.90	7.00	0.270	0.271	0.276
B0	10.45	10.50	10.60	0.411	0.413	0.417
K0	2.68	2.78	2.88	0.105	0.109	0.113
T	0.24			0.027	0.009	
t1	0.10				0.004	
10P0	39.80	40.00	40.20	1.567	1.575	1.583